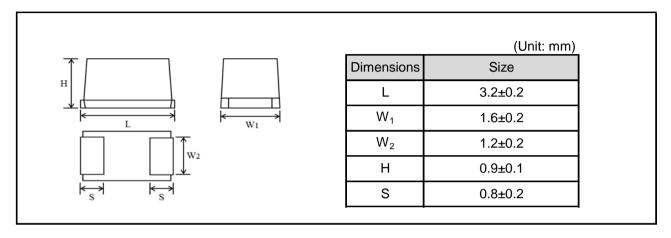
# Chip tantalum capacitors (Bottom surface electrode type : Large capacitance)

TCT series AS case Datasheet

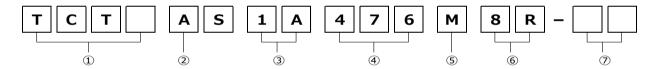
#### Features

- 1) Bottom electrode configuration results in significantly greater compactness.
- 2) Filet formation enables easy visibility after mounting.
- 3) Ideal for noise removal on power supply lines with limited space.
- 4) Eco-friendly halogen-free products.

# Dimensions



# Part No. Explanation



① Series name

**TCT** 

2 Case style

AS: 3216-3216(10)size

3 Rated voltage

Rated voltage(V)
2.5
4
6.3
10
16
20
25
35
50

4 Nominal capacitance

Nominal capacitance in pF in 3 digits: 2 significant figures followed by the figure representing the number of 0's.

**5** Capacitance tolerance

M: ±20%

6 Taping

8: Tape width

R: Positive electrode on the side opposite to sprocket hole

7 Discrimination code

# Rated table

Impedance( $\Omega$ )

Capa	citance	Rated voltage (V.DC)								
(µF)		2.5	4	6.3	10	16	20	25	35	50
1.0	(105)								8	
2.2	(225)									
3.3	(335)									
4.7	(475)									
6.8	(685)									
10	(106)									
15	(156)									
22	(226)									
33	(336)									
47	(476)			4	4					
68	(686)									
100	(107)	·		3						
150	(157)									
220	(227)		2.5							

# Marking

The indications listed below should be given on the surface of a capacitor.

- (1) Polarity: The polarity should be shown by bar. (on the anode side)
- (2) Rated DC voltage: A voltage code is shown as below table.
- (3) Capacitance: A capacitance code is shown as below table.

Voltage Code	Rated DC
Vollage Code	Voltage (V)
е	2.5
g	4
j	6.3
Α	10
С	16
D	20
Е	25
V	35
Н	50

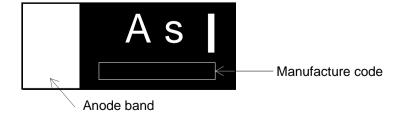
Capacitance	Nominal	Capacitance	Nominal
Code	Capacitance (µF)	Code	Capacitance (µF)
<u>E</u>	0.15	е	15
<u>N</u>	0.33	j	22
<u>S</u>	0.47	n	33
Α	1.0	S	47
E	1.5	×	68
J	2.2	a	100
N	3.3	Φ	150
S	4.7	ī	220
W	6.8	l c	330
а	10	s	470

Visual typical example

voltage code and capacitance code are variable with parts number.

[TCT series AS case]

- (1) voltage code
- (2) capacitance code



# Characteristics

Item		Performance		(has		nditions I-1 and JIS C 5101	-3)	
Operating Temp	erature	-55°C~+125°C		Voltage reduction when temperature exceeds				
Maximum operat	ina	+85℃	+85°C					
temperature with	-	765 C						
voltage derating	1110							
Rated voltage (V	'.DC)	Refer to " Standard list ".	at 85℃					
Category voltage		Refer to " Standard list ".	at 125°C					
Surge voltage (V		Refer to " Standard list ".	_	85℃				
DC Leakage cur	rent	Shall be satisfied the value on	As per 4.9 JIS C 5101-1					
		" Standard list ".	As	per 4.	5.1 JIS C 5101-3			
			Vo	ltage:	Rated voltage fo	r 5min		
Capacitance tole	rance	Shall be satisfied allowance range.	As	per 4.	7 JIS C 5101-1			
		±20%	As	per 4.	5.2 JIS C 5101-3			
			Мє	easurin	g frequency :	120 ± 12Hz		
			Me	easurin	g voltage :0	:0.5Vrms + 1.5V.DC		
			_			DC Equivalent serie	s circui	
Tangent of loss	angle	Shall be satisfied the value on	As per 4.8 JIS C 5101-1					
(Df,tanδ)		" Standard list ".	As per 4.5.3 JIS C 5101-3					
			Measuring frequency			:120 ± 12Hz		
			Measuring voltage :0			0.5Vrms + 1.5V.DC		
			Measuring circuit :DC Equivalent seri				s circui	
Impedance		Shall be satisfied the value on		•	10 JIS C 5101-1			
		" Standard list ".	As per 4.5.4 JIS C 5101-3					
					3 - 1 7	100 ± 10kHz		
			Measuring voltage :0.5Vrms or less  Measuring circuit :DC Equivalent series					
	1 4	T	_			DC Equivalent serie	s circui	
Resistance to	Appe-	There should be no significant		•	14 JIS C 5101-1			
Soldering	arance	abnormality. The indications should be clear.	As per 4.6 JIS C 5101-3					
heat	L.C.	Less than 200% of initial limit.	Dip in the solder bath Solder temp :240 ± 5°C			240 . 500		
	L.C.	Less than 200% of Initial limit.		uration	•	240 ± 5 C 10 ± 0.5s		
	⊿C/C	Within +20/-30% of initial value.	_	epetitio	-			
	20/0	Within +20/-30 % of initial value.				i e it at room tempera	aturo	
	DF	Less than 200% of initial limit.	_		· · ·	strat room tempera	iture	
	(tanδ)	Legs than 20070 of limital limit.	1.01	0 0 0 1 2	An and then mee	isare the sample.		
Temperature	Appe-	There should be no significant	As	per 4.	16 JIS C 5101-1			
cycle	arance	abnormality.		•	10 JIS C 5101-3			
•		The indications should be clear.		-	n:5 cycles			
	L.C.	Less than 200% of initial limit.	(1	cycle :	steps 1 to 4) with	nout discontinuation	١.	
	⊿C/C	Within ±30% of initial value.	$\dashv$		Temp.	Time	7	
				1	-55±3℃	30±3min	]	
	DF	Less than 200% of initial limit.		2	Room Temp.	3min or less		
	(tanδ)			3	125±2℃	30±3min	]	
				4	Room Temp.	3min or less	]	
			Aft	ter the	specimens, leave	e it at room tempera	ature	
	1		for	over 2	4h and then mea	asure the sample.		

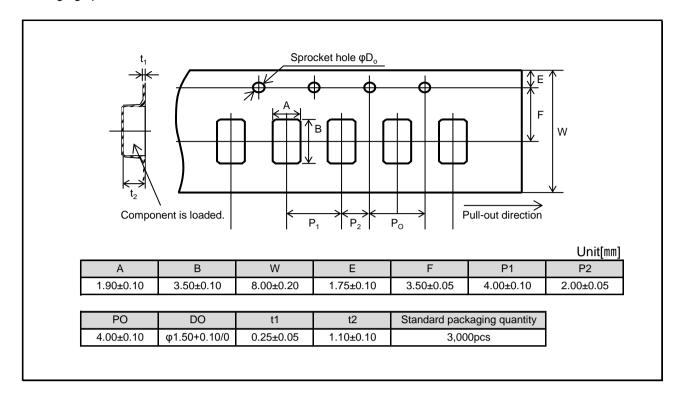
Item	1	Performance	Test conditions (based on JIS C 5101-1 and JIS C 5101-3)				
Moisture	Appe-	There should be no significant	As per 4.22 JIS C 5101-1				
resistance	arance	abnormality.	As per 4.12 JIS C 5101-3				
i e si starice	aranco	The indications should be clear.	After leaving the sample under such atmospheric				
	L.C.	Less than 200% of initial limit.	condition that the temperature and humidity are				
	L.O.	Less than 200 % of fillial liftit.	·				
	⊿C/C	Within ±20% of initial value.	60±2°C and 90 to 95% RH, respectively, for				
	⊿0/0	Within ±20% of Initial value.	500+12/0h leave it at room temperature for over 24h and then measure the sample.				
	DF	Less than 300% of initial limit.	over 2411 and then measure the sample.				
		Less than 300% of Initial limit.					
Tamananatuus	(tanδ)	FF°C	As now 4.20, HC C 5404.4				
Temperature	Temp. : -	-	As per 4.29 JIS C 5101-1				
Stability	⊿C/C	Within 0/-20% of initial value.	As per 4.13 JIS C 5101-3				
	DF	Ob all be a selectical the conduction	<del>- </del>				
		Shall be satisfied the value on					
	(tanδ)	" Standard list "					
	L.C.	-					
	Temp.:-	<u> </u> +85°C	$\dashv$				
	⊿C/C	Within +15/0% of initial value.	<del> </del>				
	20/0	Within 119/0/0 of findal value.					
	DF	Shall be satisfied the value on	<del>- </del>				
	(tanδ)	" Standard list "					
	L.C.	Less than 1000% of initial limit.	<del>- </del>				
	L.O.	Less than 1000/6 of limital limit.					
	Temp.:-	+125°C					
	⊿C/C	Within +20/0% of initial value.					
	DF	Shall be satisfied the value on					
	(tanδ)	" Standard list "					
	L.C.	Less than 1250% of initial limit.					
Surge	Appe-	There should be no significant	As per 4.26JIS C 5101-1				
voltage	arance	abnormality.	As per 4.14JIS C 5101-3				
voltago	G. G	The indications should be clear.	Apply the specified surge voltage via the serial				
	L.C.	Less than 200% of initial limit.	resistance of $1k\Omega$ ever $5\pm0.5$ min. for $30\pm5$ s.				
	0.	2000 than 20070 of finitial lifting.	each time in the atmospheric condition of				
	⊿C/C	Within ±20% of initial value.	85±2°C. Repeat this procedure 1,000 times.				
			After the specimens, leave it at room temperature				
	DF	Less than 200% of initial limit.	for over 24h and then measure the sample.				
	(tanδ)	2556 than 25676 of findal filling	1.5. 5761 2 III and then mededie the sumple.				
Loading at	Appe-	There should be no significant	As per 4.23 JIS C 5101-1				
High	arance	abnormality.	As per 4.15 JIS C 5101-1				
-	arance	The indications should be clear.	After applying the rated voltage for 1000+36/0 h				
temperature	L.C.						
	L.C.	Less than 200% of initial limit.	without discontinuation via the serial resistance				
	40/0	With: 00/ 000/ - 51 11 1	of $3\Omega$ or less at a temperature of $85\pm2^{\circ}$ C, leave				
	⊿C/C	Within +20/-30% of initial value.	the sample at room temperature / humidity for				
	DE	Long than 2000/ of initial limit	over 24h and measure the value.				
	DF	Less than 300% of initial limit.					
	(tanδ)						

Item		Performance	Test conditions (based on JIS C 5101-3)				
T	Cono	The control of the could be					
Terminal	Capa-	The measured value should be	As per 4.35 JIS C 5101-1				
strength	citance	stable.	As per 4.9 JIS C 5101-3				
	Appe-	There should be no significant	A force is applied to the terminal until it bends to				
	arance	abnormality.	1mm and by a prescribed tool maintains the				
			condition for 5s.				
			(See the figure below)				
			F(Apply force)  R230  Thickness=1.6mm				
Adhesiveness		The terminal should not come off.	As per 4.34 JIS C 5101-1				
		and terminal errodict field control offi	As per 4.8 JIS C 5101-3				
			Apply force of 2N in the two directions shown in				
			the figure below for 10±1s after mounting the				
			terminal on a circuit board.				
			Apply force A circuit board				
Dimensions		Refer to "External dimensions".	Measure using a caliper of JIS B 7507 Class				
			2 or higher grade.				
Resistance to		Refer to "External dimensions".  The indication should be clear.	2 or higher grade. As per 4.32 JIS C 5101-1				
Resistance to			2 or higher grade.  As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3				
Resistance to			2 or higher grade.  As per 4.32 JIS C 5101-1  As per 4.18 JIS C 5101-3  Dip in the isopropyl alcohol for 30±5s, at room				
Resistance to solvents		The indication should be clear.	2 or higher grade.  As per 4.32 JIS C 5101-1  As per 4.18 JIS C 5101-3  Dip in the isopropyl alcohol for 30±5s, at room temperature.				
Resistance to solvents		The indication should be clear.  3/4 or more surface area of the	2 or higher grade.  As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1				
		The indication should be clear.  3/4 or more surface area of the solder coated terminal dipped in	2 or higher grade.  As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3				
Resistance to solvents		The indication should be clear.  3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be	2 or higher grade.  As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s				
Resistance to solvents		The indication should be clear.  3/4 or more surface area of the solder coated terminal dipped in	2 or higher grade.  As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging):				
Resistance to solvents		The indication should be clear.  3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be	2 or higher grade.  As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s				
Resistance to solvents		The indication should be clear.  3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be	2 or higher grade.  As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1h.				
Resistance to solvents		The indication should be clear.  3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be	2 or higher grade.  As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1h. Solder temp.: 245±5°C				
Resistance to solvents		The indication should be clear.  3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be	2 or higher grade.  As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1h. Solder temp.: 245±5°C Duration: 3±0.5s				
Resistance to solvents		The indication should be clear.  3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be	2 or higher grade.  As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1h. Solder temp.: 245±5°C Duration: 3±0.5s Solder: M705				
Resistance to solvents  Solderability	Сара-	The indication should be clear.  3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be covered with the new solder.	2 or higher grade.  As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1h. Solder temp.: 245±5°C Duration: 3±0.5s Solder: M705 Flux: Rosin 25% IPA 75%				
Resistance to solvents  Solderability	Capa-	The indication should be clear.  3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be covered with the new solder.  Measure value should not fluctuate	2 or higher grade.  As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1h. Solder temp.: 245±5°C Duration: 3±0.5s Solder: M705 Flux: Rosin 25% IPA 75% As per 4.17 JIS C 5101-1				
Resistance to solvents  Solderability	citance	The indication should be clear.  3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be covered with the new solder.  Measure value should not fluctuate during the measurement.	2 or higher grade.  As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1h. Solder temp.: 245±5°C Duration: 3±0.5s Solder: M705 Flux: Rosin 25% IPA 75% As per 4.17 JIS C 5101-1 Frequency: 10 to 55 to 10Hz/min.				
Resistance to solvents Solderability	citance Appe-	The indication should be clear.  3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be covered with the new solder.  Measure value should not fluctuate during the measurement.  There should be no significant	2 or higher grade.  As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1h. Solder temp.: 245±5°C Duration: 3±0.5s Solder: M705 Flux: Rosin 25% IPA 75% As per 4.17 JIS C 5101-1 Frequency: 10 to 55 to 10Hz/min. Amplitude: 1.5mm				
Resistance to solvents	citance	The indication should be clear.  3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be covered with the new solder.  Measure value should not fluctuate during the measurement.	2 or higher grade.  As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.  As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1h. Solder temp.: 245±5°C Duration: 3±0.5s Solder: M705 Flux: Rosin 25% IPA 75% As per 4.17 JIS C 5101-1 Frequency: 10 to 55 to 10Hz/min.				

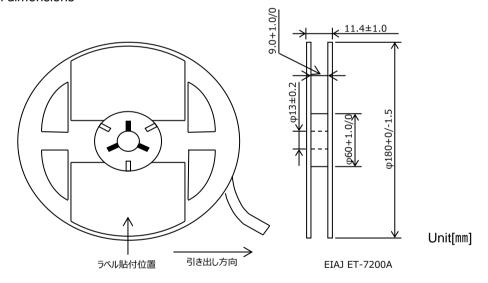
# Standard products list

	Rated	Category	Surge	Cap.	Tole-	Leakage		tanδ		Impedance
	voltage	voltage	voltage	'	rance	current		120Hz		,
	85°C	105°C	85°C	120Hz		25℃				100kHz
Part No.						1WV	-55℃	25℃	105℃	
						5min				
	(V)	(V)	(V)	(µF)	(%)	(μΑ)	(%)	(%)	(%)	(Ω)
TCTAS0G227M8R-V1	4	2.5	4	220	±20	88.0	80	30	40	2.5
TCTAS0J476M8R	6.3	4	8	47	±20	6.0	35	20	25	4
TCTAS0J107M8R	6.3	4	8	100	±20	31.5	34	18	24	3
TCTAS1A476M8R	10	6.3	13	47	±20	9.4	35	20	25	4
TCTAS1V105M8R	35	22	44	1	+20	0.7	30	15	20	8

# Packaging specifications



## Reel dimensions



# **Notice**

#### **Precaution on using ROHM Products**

1. Our Products are designed and manufactured for application in ordinary electronic equipment (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

JÁPAN	USA	EU	CHINA
CLASSⅢ	CL ACCIII	CLASS II b	CL ACCIII
CLASSIV	CLASSⅢ	CLASSⅢ	CLASSⅢ

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
  - [a] Installation of protection circuits or other protective devices to improve system safety
  - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
- 3. Our Products are designed and manufactured for use under standard conditions and not under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
  - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### **Precautions Regarding Application Examples and External Circuits**

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

### **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
  may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

#### **Precaution for Product Label**

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

#### **Precaution for Disposition**

When disposing Products please dispose them properly using an authorized industry waste company.

#### **Precaution for Foreign Exchange and Foreign Trade act**

Since concerned goods might be fallen under listed items of export control prescribed by Foreign exchange and Foreign trade act, please consult with ROHM in case of export.

#### **Precaution Regarding Intellectual Property Rights**

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